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Vishay General Semiconductor

Surface-Mount ESD Capability Rectifier



MicroSMP (DO-219AD)

Bottom View



LINKS TO ADDITIONAL RESOURCES



PRIMARY CHARACTERISTICS					
I _{F(AV)}	1.0 A				
V _{RRM} 400 V, 600 V					
I _{FSM}	15 A				
V _F at I _F = 1.0 A	0.99 V				
T _J max.	175 °C				
Package	MicroSMP (DO-219AD)				
Circuit configuration	Single				

FEATURES

- Very low profile typical height of 0.65 mm
- · Ideal for automated placement
- Oxide planar chip junction
- Low forward voltage drop, low leakage

ESD capability



AUTOMOTIVE

- \bullet Meet MSL level 1, per J-STD-020, LF maximum peak of 260 $^{\circ}\text{C}$
- AEC-Q101 qualified available
 - Automotive ordering code: base P/NHM3
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

TYPICAL APPLICATIONS

General purpose, polarity protection, and rail-to-rail protection in both consumer and automotive applications.

MECHANICAL DATA

Case: MicroSMP (DO-219AD)

Molding compound meets UL 94 V-0 flammability rating Base P/N-M3 - halogen-free, RoHS-compliant, and commercial grade

Base P/NHM3 - halogen-free, RoHS-compliant, and AEC-Q101 qualified

Terminals: matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 and HM3 suffix meet JESD 201 class 2 whisker test

Polarity: color band denotes the cathode end

MAXIMUM RATINGS (T _A = 25 °C, unless otherwise noted)						
PARAMETER	SYMBOL	MSQ1PG	MSQ1PJ	UNIT		
Device marking code		QG	QJ			
Max. repetitive peak reverse voltage	V_{RRM}	400	600	V		
Max. average forward rectified current (fig. 1)	I _{F(AV)}	1.0		А		
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load	I _{FSM}	15		А		
Operating junction and storage temperature range	T _J , T _{STG}	-55 to +175		°C		



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ELECTRICAL CHARACTERISTICS (T _A = 25 °C, unless otherwise noted)						
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT
Max. instantaneous forward voltage	I _F = 0.5 A	T _A = 25 °C	V _F ⁽¹⁾	0.99	-	V
	I _F = 1.0 A	= 1.0 A		1.09	1.2	
	$I_F = 0.5 A$	T _A = 125 °C		0.88	-	
	I _F = 1.0 A			0.99	1.05	
Max. reverse current	Rated V _R	T _A = 25 °C	I _R ⁽²⁾	-	1.0	μΑ
	nated v _R	T _A = 125 °C		6.0	50	
Typical reverse recovery time	I _F = 0.5 A, I _R	$I_F = 0.5 \text{ A}, I_R = 1.0 \text{ A}, I_{rr} = 0.25 \text{ A}$		650	-	ns
Typical junction capacitance	4.0 V, 1 MHz		CJ	4	-	pF

Notes

 $^{(1)}$ Pulse test: 300 μ s pulse width, 1 % duty cycle

(2) Pulse test: Pulse width ≤ 40 ms

THERMAL CHARACTERISTICS (T _A = 25 °C, unless otherwise noted)					
PARAMETER	SYMBOL	OL MSQ1PG MSQ1PJ		UNIT	
Typical thermal registeres	R ₀ JA (1)(2)	110		°C/W	
Typical thermal resistance	R _{0JM} (2)	30		C/VV	

Notes

(1) The heat generated must be less than the thermal conductivity from junction to ambient: $dP_D/dT_J < 1/R_{\theta JA}$

Thermal resistance $R_{\theta JA}$ – junction to ambient and $R_{\theta JM}$ - mounted on PCB with 6.0 mm x 6.0 mm copper pad areas.

IMMUNITY TO ELECTRICAL STATIC DISCHARGE TO THE FOLLOWING STANDARDS ($T_A = 25~^{\circ}\text{C}$, unless otherwise noted)						
STANDARD	TEST TYPE	TEST CONDITIONS	SYMBOL	CLASS	VALUE	
AEC-Q101-001	Human body model (contact mode)	C = 100 pF, R = 1.5 k Ω		H3B	> 8 kV	
AEC-Q101-002	Machine model (contact mode)	$C = 200 \text{ pF}, R = 0 \Omega$		M4	> 400 V	
JESD 22-A114	Human body model (contact mode)	C = 100 pF, R = 1.5 k Ω	\ \ \	3B	> 8 kV	
JESD 22-A115	Machine model (contact mode)	C = 200 pF, R = 0 Ω	V _C	С	> 400 V	
IEC 61000-4-2 (2)	Human body model (contact mode)	C = 150 pF, R = 330 Ω		4	> 8 kV	
1EC 61000-4-2 (2)	Human body model (air-discharge mode) (1)	$C = 150 \text{ pF}$. $R = 330 \Omega$		4	> 15 kV	

Notes

(1) Immunity to IEC 61000-4-2 air discharge mode has a typical performance > 30 kV

⁽²⁾ System ESD standard

ORDERING INFORMATION (Example)							
PREFERRED P/N	UNIT WEIGHT (g)	BASE QUANTITY	DELIVERY MODE				
MSQ1PJ-M3/H	0.006	1.006 H 4500 7" diameter plastic tape		7" diameter plastic tape and reel			
MSQ1PJHM3/H (1)	0.006	Н	4500	7" diameter plastic tape and reel			

Note

(1) AEC-Q101 qualified

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RATINGS AND CHARACTERISTICS CURVES (T_A = 25 °C unless otherwise noted)

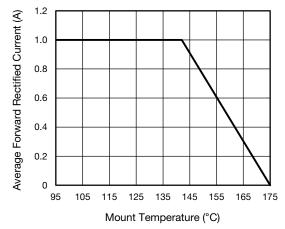


Fig. 1 - Forward Current Derating Curve

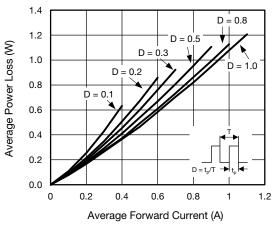


Fig. 2 - Forward Power Loss Characteristics

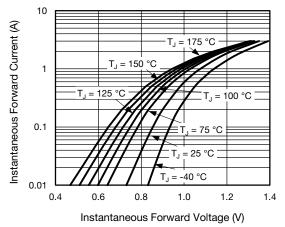


Fig. 3 - Typical Instantaneous Forward Characteristics

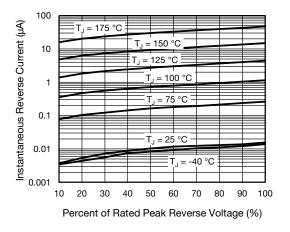


Fig. 4 - Typical Reverse Leakage Characteristics

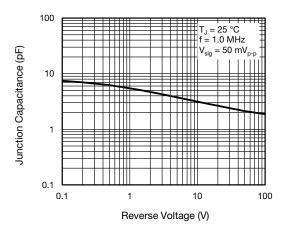


Fig. 5 - Typical Junction Capacitance

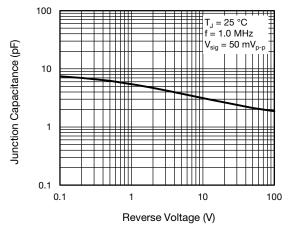


Fig. 6 - Typical Transient Thermal Impedance

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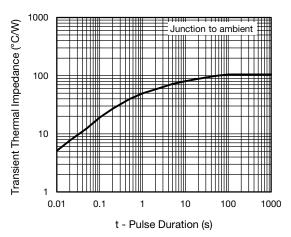
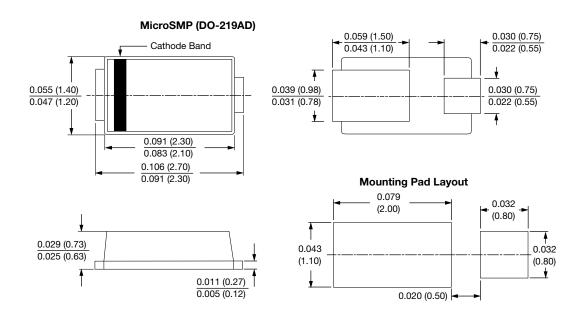


Fig. 7 - Thermal Resistance

PACKAGE OUTLINE DIMENSIONS in inches (millimeters)





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